

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : Unassigned
Applicant : BEHRENS, Jorg
Filed : Concurrently
TC/A.U. : Unassigned
Examiner : Unassigned

Confirmation No. **AP20200001 PCT/PTO 31 MAY 2006**

Docket No. : **DE03 0414 US**
Customer No. : 24738

Title: : Wire-bonded Semiconductor Component with Reinforced Inner
Connection Metallization

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

PRELIMINARY AMENDMENT

Sir:

Prior to calculation of the filing fee and examination please amend the above-identified application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims begin on page 3 of this paper.

Remarks/Arguments begin on page 4 of this paper.